

# **User Manual**

# **PPC-3060S**

Intel® Celeron® N2807 Processor based panel PC, with 6.5" color TFT LCD display



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## **Product Warranty (2 years)**

Advantech warrants to you, the original purchaser, that each of its products will be free from defects in materials and workmanship for two years from the date of purchase.

This warranty does not apply to any products which have been repaired or altered by persons other than repair personnel authorized by Advantech, or which have been subject to misuse, abuse, accident or improper installation. Advantech assumes no liability under the terms of this warranty as a consequence of such events.

Because of Advantech's high quality-control standards and rigorous testing, most of our customers never need to use our repair service. If an Advantech product is defective, it will be repaired or replaced at no charge during the warranty period. For outof-warranty repairs, you will be billed according to the cost of replacement materials, service time and freight. Please consult your dealer for more details.

If you think you have a defective product, follow these steps:

- 1. Collect all the information about the problem encountered. (For example, CPU speed, Advantech products used, other hardware and software used, etc.) Note anything abnormal and list any onscreen messages you get when the problem occurs.
- 2. Call your dealer and describe the problem. Please have your manual, product, and any helpful information readily available.
- 3. If your product is diagnosed as defective, obtain an RMA (return merchandize authorization) number from your dealer. This allows us to process your return more quickly.
- 4. Carefully pack the defective product, a fully-completed Repair and Replacement Order Card and a photocopy proof of purchase date (such as your sales receipt) in a shippable container. A product returned without proof of the purchase date is not eligible for warranty service.
- 5. Write the RMA number visibly on the outside of the package and ship it prepaid to your dealer.

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# **Declaration of Conformity**

#### CE

This product has passed the CE test for environmental specifications when shielded cables are used for external wiring. We recommend the use of shielded cables. This kind of cable is available from Advantech. Please contact your local supplier for ordering information.

#### CE

This product has passed the CE test for environmental specifications. Test conditions for passing included the equipment being operated within an industrial enclosure. In order to protect the product from being damaged by ESD (Electrostatic Discharge) and EMI leakage, we strongly recommend the use of CE-compliant industrial enclosure products.

#### **Technical Support and Assistance**

- 1. Visit the Advantech web site at http://support.advantech.com where you can find the latest information about the product.
- 2. Contact your distributor, sales representative, or Advantech's customer service center for technical support if you need additional assistance. Please have the following information ready before you call:
  - Product name and serial number
  - Description of your peripheral attachments
  - Description of your software (operating system, version, application software, etc.)
  - A complete description of the problem
  - The exact wording of any error messages

### **Safety Instructions**

- 1. Read these safety instructions carefully.
- 2. Keep this User Manual for later reference.
- 3. Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
- 4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
- 5. Keep this equipment away from humidity.
- 6. Put this equipment on a reliable surface during installation. Dropping it or letting it fall may cause damage.
- 7. The openings on the enclosure are for air convection. Protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- 8. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
- 9. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 10. All cautions and warnings on the equipment should be noted.
- 11. If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- 12. Never pour any liquid into an opening. This may cause fire or electrical shock.
- 13. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
- 14. If one of the following situations arises, get the equipment checked by service personnel:
  - The power cord or plug is damaged.
  - Liquid has penetrated into the equipment.
  - The equipment has been exposed to moisture.
  - The equipment does not work well, or you cannot get it to work according to the user's manual.
  - The equipment has been dropped and damaged.
  - The equipment has obvious signs of breakage.
- 15. DO NOT LEAVE THIS EQUIPMENT IN AN ENVIRONMENT WHERE THE STORAGE TEMPERATURE MAY GO BELOW -40° C (-40° F) OR ABOVE 60° C (140° F). THIS COULD DAMAGE THE EQUIPMENT. THE EQUIPMENT SHOULD BE IN A CONTROLLED ENVIRONMENT.
- 16. CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER, DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.
- 17. This product is intended to be supplied by a Listed Power Adapter or DC power source, rated 12-24Vdc, 5-2.5A and Tma 50 degree C, if need further assistance, please contact Advantech for further information.

The sound pressure level at the operator's position according to IEC 704-1:1982 is no more than 70 dB (A).

DISCLAIMER: This set of instructions is given according to IEC 704-1. Advantech disclaims all responsibility for the accuracy of any statements contained herein.

# **Safety Precaution - Static Electricity**

Follow these simple precautions to protect yourself from harm and the products from damage.

- To avoid electrical shock, always disconnect the power from your PC chassis before you work on it. Don't touch any components on the CPU card or other cards while the PC is on.
- Disconnect power before making any configuration changes. The sudden rush of power as you connect a jumper or install a card may damage sensitive electronic components.

### **Battery Information**

Batteries, battery packs, and accumulators should not be disposed of as unsorted household waste. Please use the public collection system to return, recycle, or treat them in compliance with the local regulations.







### Manual Conventions



Warning! Warnings indicate conditions, which if not observed, can cause personal injury!

**Caution!** Cautions are included to help you avoid damaging hardware or losing data. e.g.

> There is a danger of a new battery exploding if it is incorrectly installed. Do not attempt to recharge, force open, or heat the battery. Replace the battery only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.



Notes provide optional additional information.



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# **General Information**

This chapter gives background information on PPC-3060S panel PC.

- Sections include:
- Introduction
- Specifications
- Dimensions

### 1.1 Introduction

The PPC-3060S high value ultra slim Panel PC with industrial level TFT LCD, low power Intel® Celeron® N2807 1.58GHz Processor provides high computing performance in compact fanless embedded system.

With a high durability design, the PPC-3060S is equipped with a true-flat touch screen with IP65 front panel protection, die-cast AI Alloy enclosure and 5-wire resistive touch screen. It supports two serial ports, three USB ports, and two GbE LAN to satisfy various industrial applications.

#### **1.2 Features**

The feature of PPC-3060S includes:

- Robust Aluminum IP65 compliant front bezel
- Aesthetic ultra-thin compact fanless design with solid AI Alloy enclosure
- Embedded Intel Celeron® processor, dual core N2807 1.58GHz onboard
- One 204-pin DDR3L SO-DIMM slots (system max. 4 GB)
- Two full-size Mini PCIe card slots (one supports mSATA SSD)
- Supports SATA 6Gb/s interface for 2.5" SATA storage
- Optional Mini PCIe 802.11b/g/n wireless module
- Supports one USB 3.0

#### 1.3 Front Panel

The front side of PPC-3060S is a flat panel LCD with touch screen, which provides IP65 protection. (Figure 1.1)

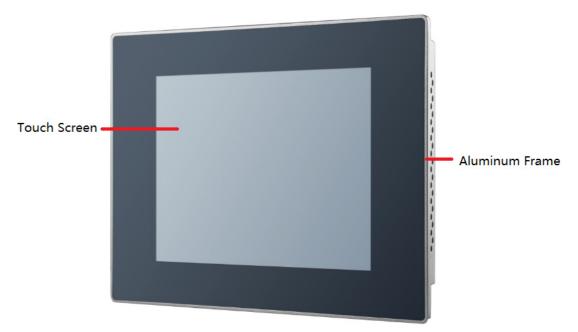


Figure 1.1 Front panel of PPC-3060S

# 1.4 Rear Panel

There are four VESA 75x75mm mounting holes and several retention screw holes on rear panel.(Figure 1.2).



Figure 1.2 Rear panel of PPC-3060S

#### 1.5 Bottom Side

The following interfaces on bottom side are: (Figure 1.3)

- 1 x Power input connector
- 1 x Power switch
- 1 x RS-232 connector (COM1)
- 1 x RS-232/422/485 connector (COM2)
- 2 x RJ45 GbE
- 1 x USB 3.0
- 2 x USB 2.0



Figure 1.3 Bottom side of PPC-3060S

# **1.6 Dimensions**

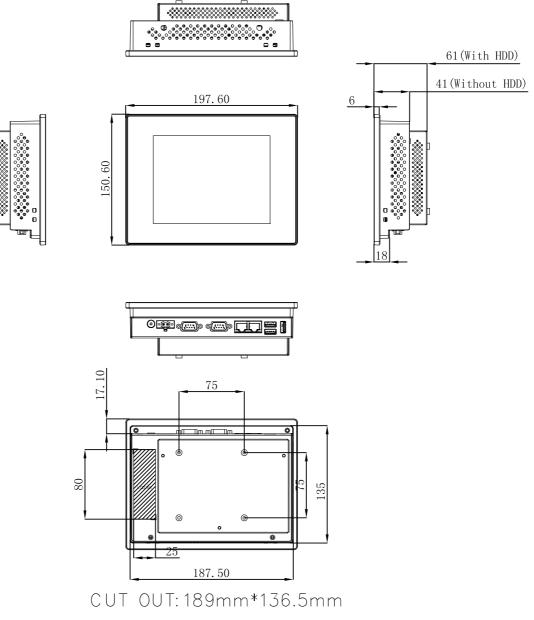


Figure 1.4 PPC-3060S Dimension

# 1.7 Specifications

#### 1.7.1 Specification Comparison

Display TypeTFT LCDResolution Max.640 x 480Brightness800Color16.2M/262kPixel Pitch0.264(H) x 0.264(V)Viewing Angle160, 140Contrast600Backlight Lifetime50,000(Min.)Touchscreen type5-w Resistive.Resolution4096 x 4096Light Transmission80.45% at 550nm wavelengthControllerRS232 interfaceDurability (Touches)Greater than 35 million touches in one location without failureEnclosureAluminumCPUIntel Celeron® N2807 1.58GHz 4.5W Dual Core onboardMemorySO DIMM x 1, DDR3L 1333, Max. 4 GBStorage 11 x 2.5' SATA slot (Optional, Need ordering HDD bracket model 98R3P30600E)Optional Storage1 x mSATANetwork (LAN)2 x RJ45 LANI x RS-232; 1 x RS-232/422/485I/O Ports2 x USB 2.0; 1 x USB 3.0 1 x Full size mini PCleOS SupportWin 7, Win 8.1, WES7, WEC7, Android, LinuxPower Consumption11 WOperating Temperature0 ~ 50°C (32 ~ 122°F) with SD 0 ~ 40°C (32 ~ 104°F)Relative Humidity10 ~ 95% @ 40°C (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60088-2-27VibrationSafety and EMCSafety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mmWeight1.5 kg	LCD Display	6.5"			
Brightness800Color16.2M/262kPixel Pitch0.264(H) x 0.264(V)Viewing Angle160, 140Contrast600Backlight Lifetime50,000(Min.)Touchscreen type5-w Resistive.Resolution4096 x 4096Light Transmission80±5% at 550nm wavelengthControllerRS232 interfaceDurability (Touches)Greater than 35 million touches in one location without failureEnclosureAluminumCPUIntel Celeron® N2807 1.58GHz 4.5W Dual Core onboardMemorySO DIMM x 1, DDR3L 1333, Max. 4 GBStorage 11 x 2.5' SATA slot (Optional, Need ordering HDD bracket model 98R3P30600E)Optional Storage1 x mSATANetwork (LAN)2 x RJ45 LANI/O Ports2 x USB 2.0; 1 x USB 3.0 1 x Full size mini PCleOS SupportWin 7, Win 8.1, WES7, WEC7, Android, LinuxPower Consumption11 WOperating Temperature $-40 - 60^{\circ}C (42 - 140^{\circ}F)$ Relative Humidity10 ~ 95% @ 40^{\circ}C (non-condensing)ShockOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Display Type	TFT LCD			
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Storage Imodel 98R3P30600E)Optional Storage1 x mSATANetwork (LAN)2 x RJ45 LAN1 x RS-232; 1 x RS-232/422/485I/O Ports2 x USB 2.0; 1 x USB 3.0 1 x Full size mini PCIeOS SupportWin 7, Win 8.1, WES7, WEC7, Android, LinuxPower Supply12 - 24 VdcPower Consumption11 WOperating Temperature $0 \sim 50^{\circ}C$ ( $32 \sim 122^{\circ}F$ ) with SSD $0 \sim 40^{\circ}C$ ( $32 \sim 104^{\circ}F$ ) with HDDStorage Temperature-40 ~ 60^{\circ}C (-40 ~ 140^{\circ}F)Relative Humidity10 ~ 95% @ 40^{\circ}C (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Memory	SO DIMM x 1, DDR3L 1333, Max. 4 GB			
Network (LAN) $2 \ge RJ45 LAN$ I $\ge RS-232; 1 \ge RS-232/422/485$ I/O Ports $1 \ge RS-232; 1 \ge RS-232/422/485$ I/O Ports $2 \ge USB 2.0; 1 \ge USB 3.0$ $1 \ge Full size mini PCle$ OS SupportWin 7, Win 8.1, WES7, WEC7, Android, LinuxPower Supply $12 - 24$ VdcPower Consumption $11 W$ Operating Temperature $0 \sim 50^{\circ}C (32 \sim 122^{\circ}F)$ with SSD $0 \sim 40^{\circ}C (32 \sim 104^{\circ}F)$ with HDDStorage Temperature $-40 \sim 60^{\circ}C (-40 \sim 140^{\circ}F)$ Relative Humidity $10 \sim 95\%$ @ $40^{\circ}C$ (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, $5 \sim 500Hz$ , 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Storage 1				
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Operating Temperature $0 \sim 50^{\circ}C (32 \sim 122^{\circ}F)$ with SSD $0 \sim 40^{\circ}C (32 \sim 104^{\circ}F)$ with HDDStorage Temperature $-40 \sim 60^{\circ}C (-40 \sim 140^{\circ}F)$ Relative Humidity $10 \sim 95\%$ @ $40^{\circ}C$ (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, $5 \sim 500$ Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Power Supply	12 - 24 Vdc			
Operating Temperature0 ~ 40°C (32 ~ 104°F) with HDDStorage Temperature-40 ~ 60°C (-40 ~ 140°F)Relative Humidity10 ~ 95% @ 40°C (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Power Consumption	11 W			
Relative Humidity10 ~ 95% @ 40°C (non-condensing)ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Operating Temperature				
ShockOperating 10G peak acceleration (11ms duration), following IEC 60068-2-27VibrationOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Storage Temperature	-40 ~ 60°C (-40 ~ 140°F)			
SNOCKIEC 60068-2-27VibrationOperating random vibration test, 5 ~ 500Hz, 1Grms with HDD; 2Grms with SSD, following IEC 60068-2-64Front Mask IP levelIP65Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Relative Humidity	10 ~ 95% @ 40°C (non-condensing)			
Vibration     2Grms with SSD, following IEC 60068-2-64       Front Mask IP level     IP65       Safety and EMC     Safety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMI       Dimensions     197.6 x 150.6 x 41 mm	Shock				
Safety and EMCSafety: CB, UL, CCC, BSMI EMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Vibration				
Safety and EMCEMC: CE, FCC Class B, BSMIDimensions197.6 x 150.6 x 41 mm	Front Mask IP level	IP65			
	Safety and EMC				
Weight 1.5 kg	Dimensions	197.6 x 150.6 x 41 mm			
	Weight	1.5 kg			

Note!

For test conditions for above power consumption, please refer to Note. Test conditions of power consumption : Memory: 4G DDR3L 1333 HDD: 500G 2.5"SATAIII OS: Window 7 32 bit Testing Software: Burn-In Test 7.0

# **1.8 Ordering Information**

ltem	Description	Image
PPC-3060S-N80AE	Panel PC with Intel Celeron® N2807 processor	
98R3P30600E	Bracket model for 2.5" SSD/HDD instal- lation	
96PSA-A90W19OT-1	Power adapter AC100 ~ 240V, 90W, 19V	I and the second
PPC-WLAN-A1E	WiFi module with antenna	The second se
PPC-ARM-A03	ARM VESA standard	
PPC-174T-WL-MTE	Wall mount kit	
PPC-Stand-A1E	Stand kit	



# System Installation & Setup

Sections include: Quick Installation Guide Install Memory Card Install HDD Install mSATA Install Wireless LAN Card Mounting the System

#### 2.1 Quick Start Guide

Before you start to set up the panel PC, take a moment to get familiar with the locations and purposes of the controls, drives, connectors and ports, which are illustrated in the figures below.

When you place the panel PC upright on the desktop, its front panel appears as shown in Figure 2.1, Frontside View, Figure 2.2 Backside View, and Figure 2.3 I/O Connectors.



Figure 2.1 Frontside View



Figure 2.2 Backside View

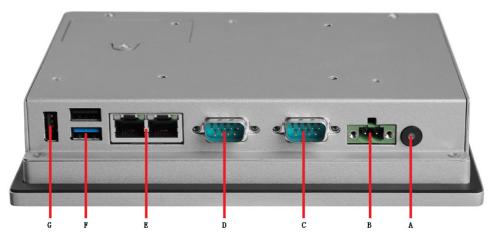


Figure 2.3 I/O Connectors

- A: Power Button B: DC In C: COM1(RS232) D: COM2(RS232/422/485)
- E: 2 x Gigabit Ethernet ports F: 1 x USB 3.0 + 1 x USB 2.0 G: 1x USB2.0

# 2.2 Installing Procedures

The following installation steps should be followed:

- 1. Install the memory card.
- 2. Install SATA HDD or mSATA storage.
- 3. Install peripheral devices.
- 4. Mount the Panel PC.
- 5. Configure the system.

#### 2.2.1 Installing Memory Card

1. Remove 4 screws and 4 stands (See Figure 2.4) and take off the rear cover.



Figure 2.4 Retention Screws on Rear Cover

2. Insert the memory card into the slot as indicated in the blue square below, and attach the thermal pad for the memory from the accessory box. Installation of the memory card is now complete. (See Figure 2.5 and 2.6)



Figure 2.5 Installation of Memory Card

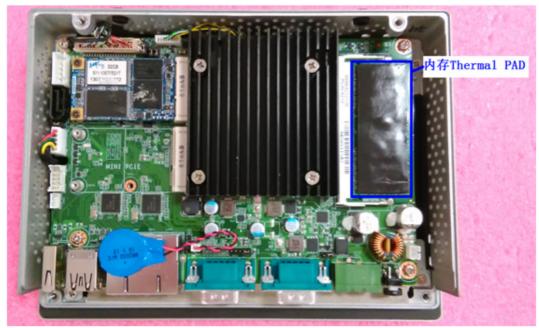


Figure 2.6 Attaching the Thermal Pad on the Memory

*Warning!* Please make sure the thermal pad (in the accessory box) is attached on the memory surface as in figure 2.6.



3. Refer to figure 2.4 Retention Screws on Rear Cover, to complete the memory installation.

#### 2.2.2 Install HDD

1. Pick up materials from HDD module (Advantech part number: 98R3P30600E), including HDD brackets, cable and screws (See Figure 2.8). Then remove the pre installed four retention screws on the HDD bracket. (See Figure 2.7)

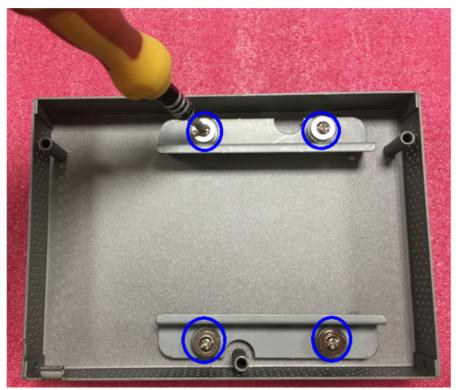


Figure 2.7 Retention Screws on the HDD Bracket

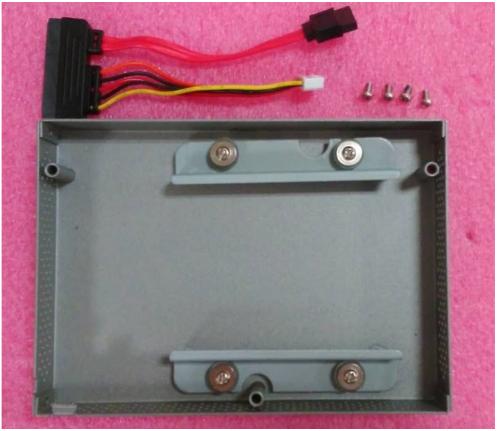


Figure 2.8 HDD Module

2. Get the SATA cable from the accessory box and connect it to the SATA HDD. (See Figure 2.9)



Figure 2.9 Connection of Cable and SATA HDD

3. Position it into the HDD cover. (See Figure 2.10)



Figure 2.10 Installing the HDD into the HDD cover

4. Loosen the screws on the mSATA door (See Figure 2.11), then remove the mSATA door.

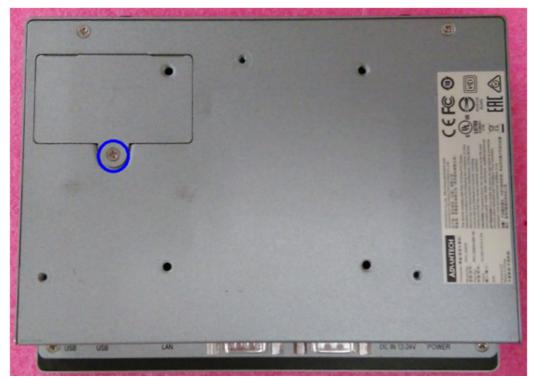
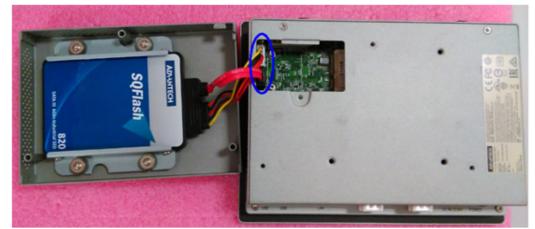


Figure 2.11 Removing the mSATA Door



5. Plug the SATA cable into the M/B's corresponding connector. (See Figure 2.12)

Figure 2.12 Connecting the SATA HDD to the Mainboard

6. Fit the HDD cover. (See Figure 2.13)

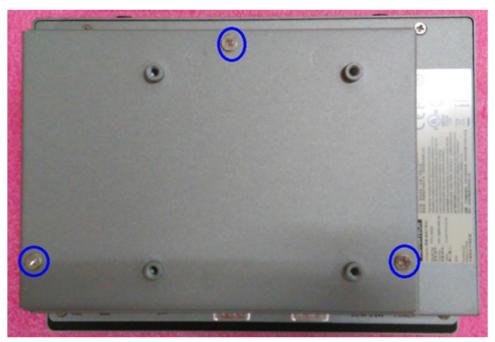


Figure 2.13 Positioning the HDD cover

#### 2.2.3 Installing mSATA

- 1. Loosen the screws on the mSATA door (See Figure 2.11), then remove the mSATA door.
- 2. Place the mSATA card into the socket, push the other end of the mSATA card down and secure the mSATA module with the two retention screws in the accessory box. (See Figure 2.14)



Figure 2.14 Installing the mSATA Module

3. Assemble the mSATA door with screw (See Figure 2.11), then complete installation of mSATA.

#### 2.2.4 Installing Wireless LAN Module

First refer to Figure 2.4, Retention Screws on Rear Cover and take off the rear cover.

#### 2.2.4.1 Full-size card mini PCIe installation

1. Insert the Mini PCIe full-size card into socket, and secure the card with the two retention screws in the accessory box. (See Figure 2.15)

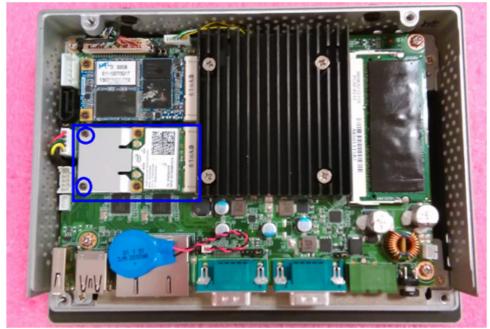


Figure 2.15 Install Full-size Wireless LAN Card

#### 2.2.4.2 Half-size card mini PCIe installation

1. Get the hexagonal screw from the accessory box, locate it in the notch on the PCB and secure it. (See Figure 2.16)



Figure 2.16 Location of Retention Screws

2. Insert the mini PCIe half-size card into the socket at an angle, and secure with a screw from the accessory box.(See Figure 2.17)



Figure 2.17 Install Half-size Wireless LAN Card

3. Install the antenna. (See Figure 2.18 and Figure 2.19)



Figure 2.18 Antenna Cables of Full-size mini PCIe LAN Module



Figure 2.19 Antenna Cables of Half-size Mini PCIe LAN Module

4. Refer to figure 2.4 Retention Screws on Rear Cover to replace cover.

# 2.3 Mounting the System

*Warning!* When mounting the panel PC, it is advisable to have more than one person help with the installation to prevent accidental damage to the panel and avoid personal injury.

The methods of mounting the panel PC are:

- Wall Mounting
- Panel Mounting
- Arm Mounting
- Stand Mounting

The mounting methods are described in the following sections.

#### 2.3.1 Wall Mounting

To mount the panel PC onto a wall, please follow the Figure 2.20.

- 1. Select the location on the wall for the wall mounting bracket.
- 2. Mark the locations of the two screws holes in the bracket on the wall.
- 3. Drill two pilot holes at the marked locations on the wall
- 4. Align the wall-mounting bracket screw holes with the pilot holes.

5. Secure the mounting-bracket to the wall by inserting the retention screws into the two pilot holes and tighten them.

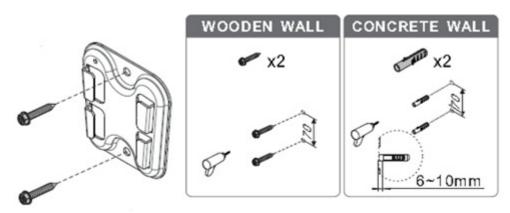


Figure 2.20 Mounting the Bracket on the Wall

6. Insert M4 screws into the four screw holes on the real panel and tighten until the screw shank is secured against the rear panel.

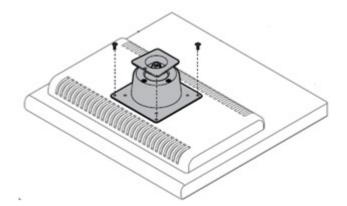
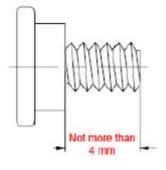


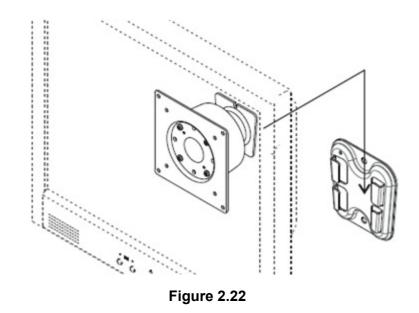
Figure 2.21 Location of the Four Screws on the Rear Panel

*Warning!* Please make sure the thread depth of the screw for rear panel should be no more than 4mm.





7. Align the Panel PC into the mounting bracket on the wall. (Figure 2.22)



8. Secure the panel PC by fastening the retention screw of the wall-mounting bracket. (Figure 2.23)

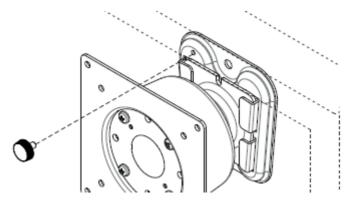


Figure 2.23 Secure the Panel PC

#### 2.3.2 Panel Mounting

To mount the flat bezel panel PC into a panel, please follow the steps below.

1. Cut out a section corresponding to the size shown below. The dimensions are in mm. (See Figure 2.24)

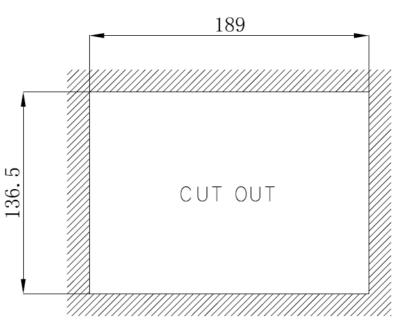


Figure 2.24 PPC-3060S Cut-out Dimensions

2. Put the machine into the cabinet and take out the eight hook brackets from the accessory box. (See Figure 2.25)

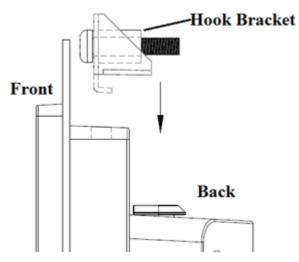


Figure 2.25 Hook Brackets for Panel Mounting

3. Put the hook brackets into the holes according to the arrow and hookup the machine. (See Figure 2.26)

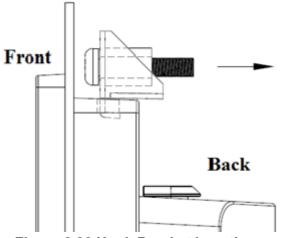


Figure 2.26 Hook Bracket Locations

4. Lock screws and fixed machine. (See Figure 2.27)

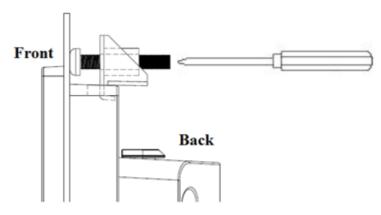


Figure 2.27 Fasten the Hook Bracket

See finished view. (See Figure 2.28)

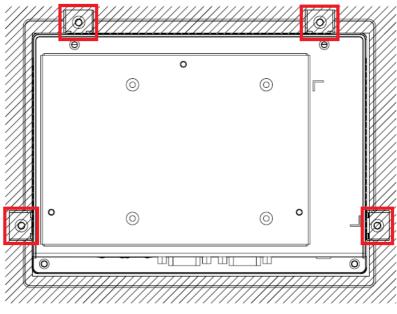


Figure 2.28 Back-side View of Panel Mounting

#### 2.3.3 Arm Mounting

PPC-3060S is a VESA compliant panel PC and can be mounted on an arm with a 75mm interface pad. To mount PPC-3060S on an arm, please follow the steps below.

- 1. Refer to the installation instruction of the mounting arm to correctly mount the arm onto the surface as a base.
- 2. Align the retention screw holes on the mounting arm interface with the VESA holes in the panel PC, and secure the panel PC with four M4 retention screws. (see Figure 2.29)



#### Figure 2.29 Arm mounting

*Warning!* Please make sure the thread depth of the screw for the rear panel are no more than 4mm.



#### 2.3.4 Stand Mounting

Before Stand Mounting, please check the packing list first

No.	Name	Qty.	Pic.	No.	Name	Qty.	Pic.
A	Screw (M4x8L)	12 (4 x spare)	V	в	Screw (M4x6L)	6 (2 x spare)	
с	Screw (M4x5L)	2 (1 x spare)	6	1	Hinge	1	
2	VESA Bracket	1		3	Hinge Cover	1	
4	Base Plate	1	-				

To mount the panel PC to stand, please follow the steps below

1. As shown in the figure below use four No. A screws in the packing list to lock the VESA BKT to the machine. Depending on your needs, you can choose between using 75\*75 mm or 100\*100 mm of VESA mount.

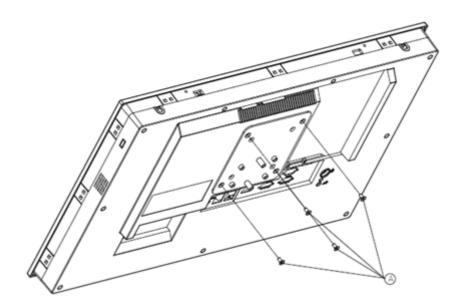


Figure 2.30 Screw Holes

2. As the figure below shows, use four No. A screws in packing list to lock on the base plate.

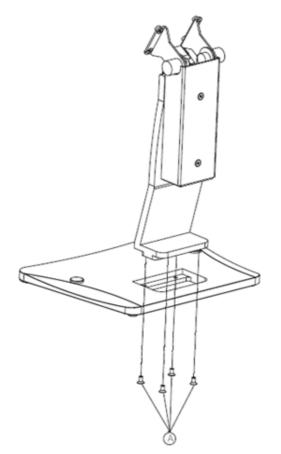


Figure 2.31 Securing the Base

3. As the figure below shows use four No. B screws in the packing list to secure the VESA Bracket.

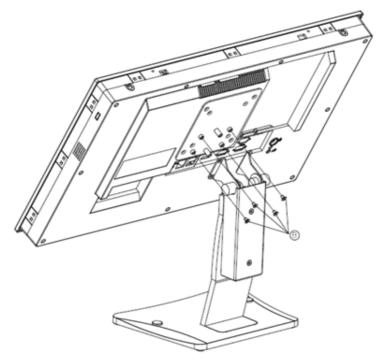


Figure 2.32 Securing VESA Bracket

4. As the figure below shows, use one No. C screw in the packing list to secure the hinge cover.

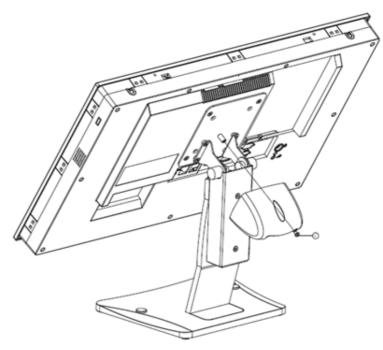


Figure 2.33 Securing the Hinge Cover

Completed view of stand mounted PPC machine

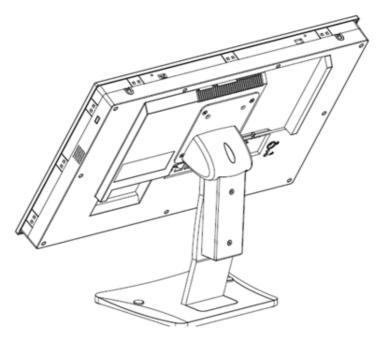


Figure 2.34 Secured Hinge Cover



# **Jumper Setting**

Sections include:

- Jumper & Connectors
- External COM Ports and Pin Definitions

### 3.1 Motherboard layout diagram

Below is the motherboard layout diagram, internal peripheral connectors can be found in this diagram and accessible when the motherboard is outside of the chassis.

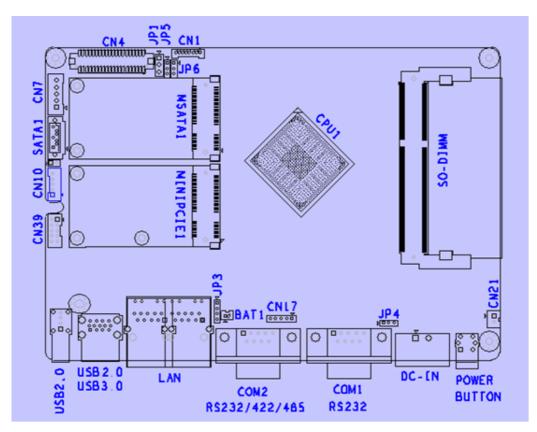


Figure 3.1 Mother board layout diagram (front side)

#### **3.2** Internal jumpers and connectors

The table shows a list of internal jumpers and connectors in the motherboard, pinouts can be found in the table.

Table 3.1: Internal jumpers and connectors					
Connectors	Function	Туре			
CN1	LVDS backlight connector	Wafer 8P 1.25mm			
CN4	LVDS connector	Wafer 20x2P 1.25mm			
CN7	SATA power connector	Wafer 5P 2.5mm			
SATA1	SATA connector	SATA 7P connector			
CN10	Touch screen connector	Wafer 5P 2.0mm			
CN17	COM1 PIN9 power select connector	Pin header 5P 2.0mm			
CN21	Power button	Wafer 2P 2.0mm			
CN39	LPC connector	Wafer 5x2P 2.0mm			
JP1	LVDS power select jumper	Pin header 3P 2.54mm			
JP3	RTC select jumper	Pin header 4P 2.0mm			
JP4	ATX/AT select jumper	Pin header 3P 2.0mm			
JP5	LVDS PWM power select jumper	Pin header 3P 2.0mm			
JP6	LVDS enable power select jumper	Pin header 3P 2.0mm			

### 3.2.1 LVDS power select jumper

JP1	lcon	LVDS Power Select Jumper	
(1-2)	P1	5V	
(2-3)	P2	3.3V	Default*





### 3.2.2 LVDS PWM power select jumper

JP5	lcon	LVDS PWM Power Select Jumper	
(1-2)	P3	5V	
(2-3)	P4	3.3V	Default*





### 3.2.3 LVDS enable power select jumper

JP6	lcon	LVDS Enable Pow	LVDS Enable Power Select Jumper	
(1-2)	P5	5V		
(2-3)	P6	3.3V	Default*	





### 3.2.4 RTC select

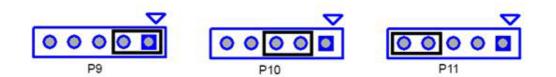
JP3	Icon	RTC Select	
(2-3)	P7	Normal	Default*
(3-4)	P8	Clear CMOS	





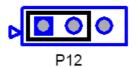
### 3.2.5 COM1 Pin 9 select

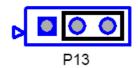
CN17	lcon	COM1 PIN9 Power Select		
(1-2)	P9	COM1 RI	Default*	
(2-3)	P10	COM1 PIN9 5V		
(4-5)	P11	COM1 PIN9 12V		



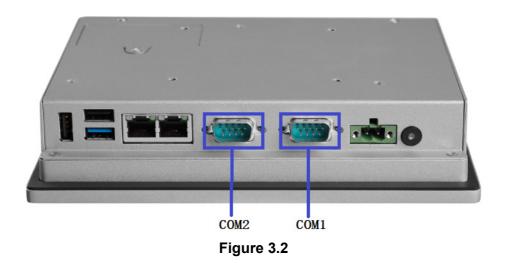
### 3.2.6 ATX/AT select

JP4	lcon	ATX/AT Select	
(1-2)	P12	AT	
(2-3)	P13	ATX	Default*





# 3.3 External COM Ports and Pin Definitions



### COM 1: RS232

COM1 Pin9 is set as RI signal by default and also can be set as 5 V or 12 V output via jumper setting.

COM2: RS232/422/485

No	ote!

COM2 does not support RING function.

	COM1		CO	M2
PIN	RS232	RS232	RS422	RS485
1	DCD	DCD	TX-	DATA-
2	RXD	RXD	TX+	DATA+
3	TXD	TXD	RX+	NC
4	DTR	DTR	RX-	NC
5	GND	GND	NC	NC
6	DSR	DSR	NC	NC
7	RTS	RTS	NC	NC
8	CTS	CTS	NC	NC
9	RING or 5V/12V Output	RING	NC	NC

PPC-3060S User Manual



# Software Setup

Sections include: ■ Installing ng Drivers ■ BIOS Setup Program

# 4.1 Installing Divers

When you install the OS in the panel PC for the first time, you should also install the corresponding drivers to make sure all the functions work properly.

You can download the drivers from the below ling:

http://www.advantech.com



Before Windows 8.x or Android is installed, first change the BIOS settings as explained in the OS Selection section; otherwise, the installation will fail. If Windows 7 is installed, it is not necessary to change the BIOS settings.

# 4.2 BIOS Setup Program

### 4.2.1 Update BIOS

1. When entering the BIOS menu, select "Advanced  $\rightarrow$  Security configuration  $\rightarrow$  TXE HMRFPO  $\rightarrow$  enable".

Aptio Setur Utility Advanced	– Sopyright (S) 2013 Am	erican Megatrends, Inc.
Intel(R) TXE Configuration TXE TXE HMRFPO TXE Firmware Update TXE EOP Message TXE Unconfiguration Perform	[Enabled] [Disabled] [Enabled] [Enabled]	
	TXE HMRFPO Enabled Disabled	++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defau. F4: Save & Exit ESC: Exit
Version 2.16.1242.	Copyright (C) 2013 Amer	ican Megatrends, Inc.

- 2. Restart the computer.
- 3. Execute AFUDOS 8211BIOS.bin /P /B /N /X /ME.
- 4. Power on the system again after it is powered off.
- 5. The BIOS is then updated.

### 4.2.2 Entering BIOS Setup

When the power is turned on, press the <Del> button to enter BIOS setup screen. Whenever a change is made, press <F4> to save and exit; otherwise the settings will not be saved in the BIOS.

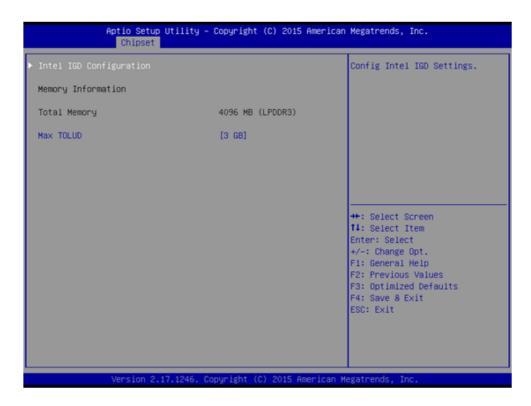
BIOS Information       American Megatrends       Set the Time. Use Tab to         BIOS Vendor       American Megatrends       Switch between Time elements.         Core Version       5.0.0.9       0.15 x64         Compliancy       UEFI 2.3; PI 1.2       Switch between Time elements.         Project Version       PCM 8212T009       Switch between Time elements.         BayTrail SoC       CO Stepping       O1.00.02.1060         System Date       [Thu 09/24/2015]       +:: Select Screen         System Time       [10:05:16]       +:: Select Item         Access Level       Administrator       +:: Select Screen         H: Select Item       Enter: Select       +/-: Change Opt.         F1: General Help       F2: Previous Values       F3: Optimized Defaults         F3: Optimized Defaults       F4: Save & Exit       ESC: Exit	Aptio Setup Utility - Main Advanced Chipset Security	Copyright (C) 2015 American Boot Save & Exit	Megatrends, Inc.
<b>†1:</b> Select Item         Enter: Select         +/-: Change Opt.         F1: General Help         F2: Previous Values         F3: Optimized Defaults         F4: Save & Exit	BIDS Vendor Core Version Compliancy Project Version Build Date and Time BayTrail SoC TXE FW Version System Date	5.0.0.9 0.15 x64 UEFI 2.3; PI 1.2 PCM 8212T009 09/24/2015 09:18:01 C0 Stepping 01.00.02.1060 [Thu 09/24/2015]	
	Access Level	Administrator	<pre>f1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save &amp; Exit</pre>

### 4.2.3 Adjustment of LCD Brightness

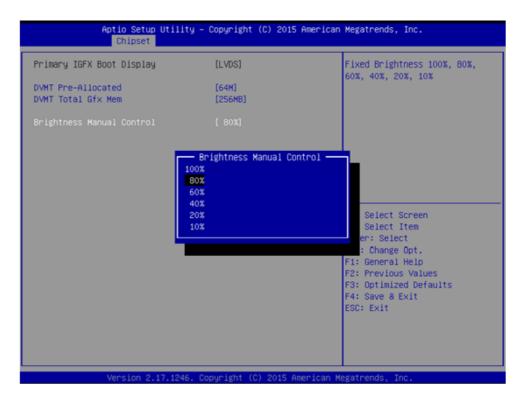
1. Select "Host Bridge" in "Chipset" tab.

North Bridge	North Bridge Parameters
South Bridge	
	++: Select Screen
	14: Select Item Enter: Select
	+/-: Change Opt. F1: General Help
	F2: Previous Values
	F3: Optimized Defaults F4: Save & Exit
	ESC: Exit

2. Then select "Intel IGD Configuration".



3. Select "Brightness Manual Control" and there will be six brightness levels to choose from.



# Chapter 4 Software Setup

### 4.2.4 COM2 Mode Selection (RS232/RS422/RS485)

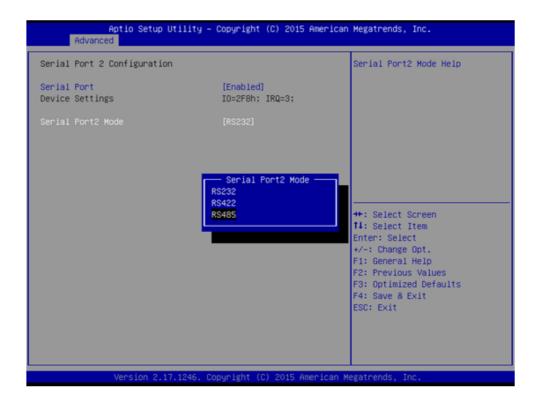
1. Select "NCT5523D Super IO Configuration" in the "Advanced" tab.

<ul> <li>ACPI Settings</li> <li>NCT5523D Super ID Configuration</li> <li>Hardware Monitor</li> <li>SS RTC Wake Settings</li> <li>CPU Configuration</li> <li>PPM Configuration</li> <li>IDE Configuration</li> <li>Network Stack Configuration</li> <li>CSM Configuration</li> <li>USB Configuration</li> <li>Security Configuration</li> </ul>	System Super IO Chip Parameters.
	++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

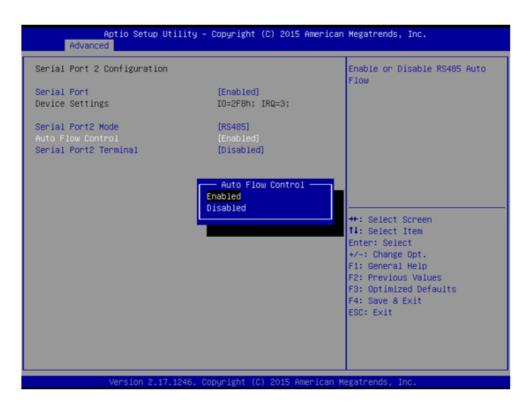
2. Select "Serial Port 2 Configuration" and then click

NCT5523D Super IO Configuration		Set Parameters of Serial Port
Super IO Chip • Serial Port 1 Configuration • Serial Port 2 Configuration • Serial Port 3 Configuration	NCT5523D	2 (COMB)
		++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

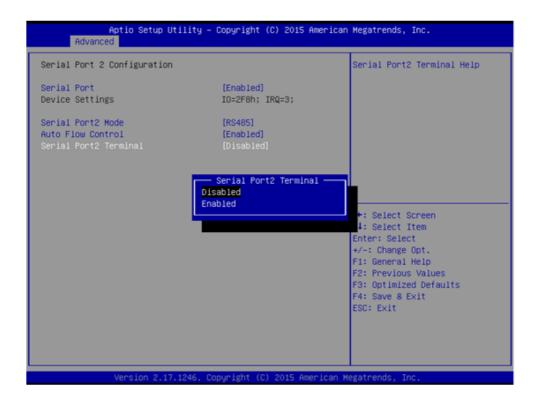
3. Select "Serial Port 2 Mode" and then click to select COM2 operation mode [RS232] or [RS422] or [RS485].



4. When COM2 Mode is selecting RS485, "Auto Flow Control" also can select [Enabled] or [Disabled]



5. When COM2 Mode is selecting RS485, "Serial Port2 Terminal" also can select [Enabled] or [Disabled]



### 4.2.5 OS Selection

1. Select "South Bridge" in the "Chipset" tab.



2. Different OS can be selected through "OS Selection" [Windows 7]/[Android]/ [Windows 8.X]

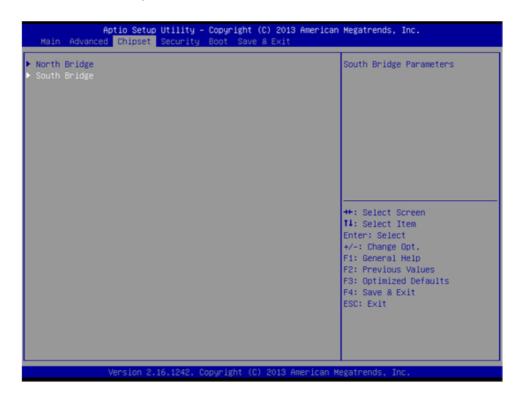


"OS Selection" is preset as Windows 7, which needs to be changed when Windows 8.x or Android OS is installed.

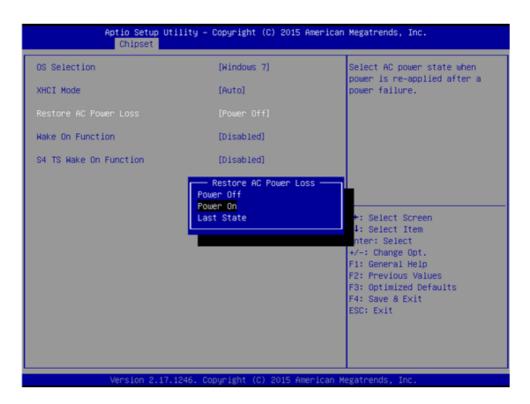
Aptio Setup Utility - Chipset	- Copyright (C) 2015 American	Megatrends, Inc.
OS Selection	[Windows 7]	OS Selection
XHCI Mode	(Auto)	
Restore AC Power Loss	[Power Off]	
Wake On Function	[Disabled]	
S4 TS Wake On Function	[Disabled]	
	OS Selection Windows 8.X Android Windows 7	++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
Version 2.17.1246. (	Copyright (C) 2015 American M	legatrends, Inc.

### 4.2.6 BIOS AT & ATX Setup

1. Select "South Bridge" in the "Chipset" tab.



- Chapter 4 Software Setup
- 2. In "Restore AC Power Loss", set "Power On" to "AT" and "Power Off" to "ATX".

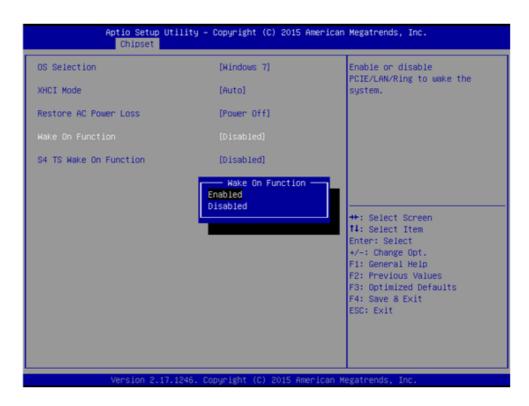


### 4.2.7 Wake on LAN

1. Select "South Bridge" in the "Chipset" tab.

Aptio Setup Utility – Copyright (C) 2013 Americar Main Advanced <mark>Chipset</mark> Security Boot Save & Exit	Megatrends, Inc.
▶ North Bridge ▶ South Bridge	South Bridge Parameters
	<pre>++: Select Screen t1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save &amp; Exit ESC: Exit</pre>
Version 2.16.1242.Copyright (C) 2013 American N	legatrends, Inc.

2. Set "Wake on Function" to "Enabled".

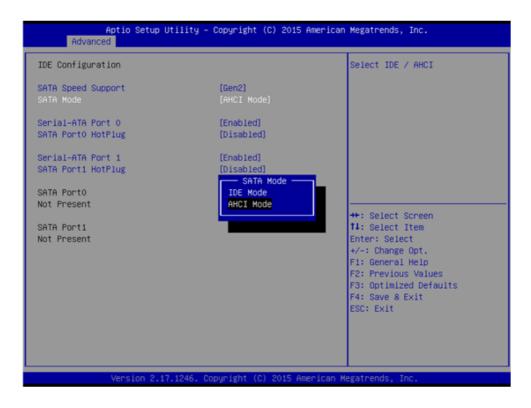


### 4.2.8 SATA Mode Selection

1. Select "IDE Configuration" in the "Advanced" tab.



#### 2. Select "SATA Mode".



### 4.2.9 Boot Options

1. Select "CSM Configuration" in the "Advanced" tab.

Aptio Setup Utility – Copyright (C) 2015 American Main Advanced Chipset Security Boot Save & Exit	Megatrends, Inc.
<ul> <li>ACPI Settings</li> <li>NCT5523D Super IO Configuration</li> <li>Hardware Monitor</li> <li>SS RTC Wake Settings</li> <li>CPU Configuration</li> <li>PPM Configuration</li> <li>IDE Configuration</li> <li>Network Stack Configuration</li> <li>CSM Configuration</li> <li>USB Configuration</li> <li>Security Configuration</li> </ul>	CSM configuration: Enable/Disable, Option ROM execution settings, etc. ++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
Version 2.17.1246. Copyright (C) 2015 American Me	gatrends, Inc.

2. Select "Boot option filter".

# Note!

Boot option is set as "Legacy only" by default. If "UEFI only" is selected, only Windows 7 64bits or Windows 8.x 64bits can be supported. If UEFI 32bit OS is required, please update BIOS.

Aptio Setup Ut Advanced	ility – Copyright (C) 2013 Americ	can Megatrends, Inc.
Compatibility Support Module	This option controls	
Option ROM Messages	[Fonce BIOS]	Legacy/UEFI ROMs priority
Boot option filter	[UEFI and Legacy]	
Option ROM execution		
Network Video Other PCI devices	(Do not launch) [Legacy] Boot option filter UEFI and Legacy Legacy only UEFI only	<pre>++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save &amp; Exit ESC: Exit</pre>
Version 2.16.	1242. Copyright (C) 2013 Americar	n Megatrends, Inc.



**BSMI** RoHS

# A.1 BSMI RoHS

設備名稱: 電腦 型號 (型式): PPC-3060S series Equipment name Type designation (Type)					
限用物質及其化學符號 Restricted substances and its chemical symbols					
鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr <sup>+6</sup> )	多溴聯苯 Polybromina ted biphenyls (PBB)	多溴二苯醚 Polybrominate d diphenyl ethers (PBDE)
	0	0	0	0	0
	0	0	0	0	0
	0	0	0	0	0
	0	0	0	0	0
_	0	0	0	0	0
備考 1. "超出 0.1 wt %"及 "超出 0.01 wt %"係指限用物質之百分比含量超出百分比含 量基準值。 Note 1. "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.					
<ul> <li>備考 2. "○"係指該項限用物質之百分比含量未超出百分比含量基準值。</li> <li>Note 2. "○"indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.</li> <li>備考 3. "一"係指該項限用物質為排除項目。</li> </ul>					
	(Pb) — — — — — — — — — — — — —	鉛 Lead (Pb)       汞 Mercury (Hg)         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         —       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ④       〇         ⑤       〇         ⑤       〇         ⑥       ⑤         ⑥       ⑥ </td <td>器 Lead (Pb)       汞 Mercury (Hg)       鎘 Cadmium (Cd)         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         個       ○</td> <td>Restricted substances and its cher         鉛 Lead       汞 Mercury       鍋       六價路         (Pb)       泉 Mercury       鍋       Cadmium       六(百銘)         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○<!--</td--><td>Restricted substances and its chemical symbols         鍋 Lead       汞 Mercury       鎘       六價鉻       多溴聯苯         (Pb)       汞 Mercury       傓       hexavalent       Polybrominated         (Pb)       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -</td></td>	器 Lead (Pb)       汞 Mercury (Hg)       鎘 Cadmium (Cd)         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         —       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         ④       ○       ○         個       ○	Restricted substances and its cher         鉛 Lead       汞 Mercury       鍋       六價路         (Pb)       泉 Mercury       鍋       Cadmium       六(百銘)         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○ </td <td>Restricted substances and its chemical symbols         鍋 Lead       汞 Mercury       鎘       六價鉻       多溴聯苯         (Pb)       汞 Mercury       傓       hexavalent       Polybrominated         (Pb)       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -</td>	Restricted substances and its chemical symbols         鍋 Lead       汞 Mercury       鎘       六價鉻       多溴聯苯         (Pb)       汞 Mercury       傓       hexavalent       Polybrominated         (Pb)       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -       ○       ○       ○       ○         -



China ROHS

# **B.1 China ROHS**

Dear Customer,

Thanks for choosing Advantech Product, to comply with China Electronic Industry Standard SJ/T11364 which require Marking for the Restriction of the Use of Hazardous Substances in Electrical and Electronic Products, herein report to you product's environmental protection as follows, Please disregard this notice if the product is not to be sold / installed in China

Model name	PPC-3060S Series						
Substance	Name and c	Name and concentration of hazardous substances contained in product					
	Lead (Pb)	Hygrargyrum (Hg)	Cadmium (Cd)	hexavalent chrome (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)	
Battery	Х	0	0	0	0	0	
Touchscreen	Х	0	0	0	0	0	
Copper stub	Х	0	0	0	0	0	
Eelectronic parts and components	x	0	0	0	0	0	

O: Represent the concentration for this hazardous substance in all homogeneous materials of the part Comply with the limit of the standard of GB/T 26572.

X: Represent the concentration for this hazardous substance at least in one homogeneous material of this part exceeds the limit of the standard of GB/T 26572.

Enterprise statements:( for those exceeding the standard) Content:

The mark of EPUP (Environmental Protection Use Period) in product label means in this period, by the normal operation mode, the hazardous substances won't leak out and deviate, so the product use won't result in serious environmental pollution, human injury or property loss, meanwhile, please don't take this period as the warranty date.

The products which attach with pollution control mark can be recycled, and should not be discarded at will.



Watchdog Timer Programming Example

## C.1 Watchdog Timer Programming Example

The watchdog timer is provided to ensure that standalone systems can always recover from catastrophic conditions that cause the CPU to crash.

This condition may have occurred by external EMI or a software bug. When the CPU stops working correctly, watchdog timer either performs a hardware reset to bring the system back to a known state.

The following watchdog timer example code is written in Intel 8086 assembly language, applies to DOS environment. And can be setup to 255 timer levels by software.

-----

; Enter the Extended Function Mode

MOV DX, 2EH ; dependency by HW strap to 2Eh MOV AL, 87H OUT DX, AL OUT DX, AL

;-----

; Configure Logical Device 8, Configuration Register CR30

;-----

MOV DX, 2EH MOV AL, 07H OUT DX, AL ; point to Logical Device Number Reg. MOV DX, 2FH MOV AL, 08H OUT DX, AL ; select Logical Device 8

;set WDT logic device to active

;-----

MOV DX, 2EH MOV AL, 30H OUT DX, AL ; select CR30 MOV DX, 2FH MOV AL, 01H OUT DX, AL ;set WDT active

;initial WDT mode

·\_\_\_\_\_

;-----MOV DX, 2EH MOV AL, F0H OUT DX, AL MOV DX, 2FH MOV AL, 00H ; bit0: 0-Pulse Mode, 1- Level mode; bit3: 0- second mode, 1- minute mode;

------

OUT DX, AL ;set second mode, default value

;-----

;set WDT time-out value

;-----MOV DX, 2EH MOV AL, F1H OUT DX, AL MOV DX, 2FH MOV AL, 05H OUT DX, AL ;set time-out value is 5s; 00- time-out disable

;-----

; Exit the Extended Function Mode

;-----

MOV DX, 2EH MOV AL, AAH OUT DX, AL



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